

MRI100.12F

2 in 1 IGBT Modules

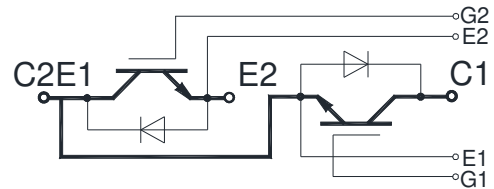
Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=100A / I_{CRM}=200A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- High power and thermal cycling capability



Typical Applications

- High Frequency Switching Application
- Motor drives
- UPS system



IGBT, Inverter

Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^{\circ}C$	V_{CES}	1200	V
Continuous DC collector current	$T_C = 80^{\circ}C, T_{vj\ max} = 150^{\circ}C$	$I_{C\ nom}$	100	A
Repetitive peak collector current	$t_p = 1\ ms$	I_{CRM}	200	A
Total power dissipation	$T_C = 25^{\circ}C, T_{vj\ max} = 175^{\circ}C$	P_{tot}	502	W
Gate-emitter peak voltage		V_{GES}	+/- 20	V

IGBT, Inverter
Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current	$T_C = 80^{\circ}\text{C}, T_{vj} \text{ max} = 150^{\circ}\text{C}$	$I_{C \text{ nom}}$	100	A
Repetitive peak collector current	$t_P = 1 \text{ ms}$	I_{CRM}	200	A
Total power dissipation	$T_C = 25^{\circ}\text{C}, T_{vj \text{ max}} = 175^{\circ}\text{C}$	P_{lot}	502	W
Gate-emitter peak voltage		V_{GES}	+/- 20	V

Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 100 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, \text{sat}}$		$T_{vj} = 25^{\circ}\text{C}$	1.92	V
				$T_{vj} = 125^{\circ}\text{C}$	2.21	V
				$T_{vj} = 150^{\circ}\text{C}$	2.28	V
Gate threshold voltage	$I_C = 3.8 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, \text{th}}$	5.2	5.9	6.6	V
Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		7.5		Ω
Input capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}		9.6		nF
Reverse transfer capacitance	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{res}		0.01		nF
Collector-emitter cut-off current	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			100	nA
Turn-on delay time, inductive load	$I_C = 100 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 4.1 \Omega$	$t_{d, \text{on}}$		$T_{vj} = 25^{\circ}\text{C}$	0.15	us
				$T_{vj} = 125^{\circ}\text{C}$	0.17	us
				$T_{vj} = 150^{\circ}\text{C}$	0.18	us
Rise time, inductive load	$I_C = 100 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 4.1 \Omega$	t_r		$T_{vj} = 25^{\circ}\text{C}$	0.03	us
				$T_{vj} = 125^{\circ}\text{C}$	0.04	us
				$T_{vj} = 150^{\circ}\text{C}$	0.04	us

(table continues...)

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load	$I_C = 100A, V_{CE} = 600V$	$T_{vj} = 25^\circ C$		0.17		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$	$t_{d,off}$	0.19		us
	$R_{G,on} = 4.1\Omega$	$T_{vj} = 150^\circ C$		0.20		us
Fall time, inductive load	$I_C = 100A, V_{CE} = 600V$	$T_{vj} = 25^\circ C$		0.20		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$	t_f	0.24		us
	$R_{G,on} = 4.1\Omega$	$T_{vj} = 150^\circ C$		0.25		us
Turn-on energy loss per pulse	$I_C = 100A, V_{CE} = 600V, L_s=30nH$	$T_{vj} = 25^\circ C$		8.42		mJ
	$V_{GE} = +15/-15V, di/dt = 1870A/\mu s$	$T_{vj} = 125^\circ C$	E_{on}	10.5		mJ
	$R_{G,on} = 4.1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		11.5		mJ
Turn-off energy loss per pulse	$I_C = 100A, V_{CE} = 600V, L_s=30nH$	$T_{vj} = 25^\circ C$		7.89		mJ
	$V_{GE} = +15/-15V, dv/dt = 7410V/\mu s$	$T_{vj} = 125^\circ C$	E_{off}	9.59		mJ
	$R_{G,off} = 4.1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		10.3		mJ
SC data	$V_{GE} \leq 15V, V_{CC} = 600V, t_p \leq 8\mu s, T_{vj} = 150^\circ C, C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		I_{SC}	556		A
Thermal resistance, junction to case	Per IGBT		$R_{th,JC}$		0.298	K/W

Diode, Inverter

Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current		I_F	100	A
Repetitive peak forward current	$t_p = 1\text{ ms}$	I_{FRM}	200	A

Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	$I_F = 100A, V_{GE} = 0V$	V_F		1.69		V	
			$T_{vj} = 25^\circ C$		1.77		V
			$T_{vj} = 150^\circ C$		1.71		V

(table continues...)

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current	$I_F = 100A, V_R = 600V$	$T_{vj} = 25^\circ C$		89.7		A
	$V_{GE} = -15V, -di_F/dt = 1300 A/\mu s$	$T_{vj} = 125^\circ C$	I_{RM}	110.7		A
	$R_{G,off} = 4.1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		117.8		A
Recovered charge	$I_F = 100A, V_R = 600V$	$T_{vj} = 25^\circ C$		15.1		μC
	$V_{GE} = -15V, -di_F/dt = 1300 A/\mu s$	$T_{vj} = 125^\circ C$	Q_r	18.1		μC
	$R_{G,off} = 4.1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		19.5		μC
Reverse recovery energy	$I_F = 100A, V_R = 600V$	$T_{vj} = 25^\circ C$		5.13		mJ
	$V_{GE} = -15V, -di_F/dt = 1300 A/\mu s$	$T_{vj} = 125^\circ C$	E_{rec}	6.25		mJ
	$R_{G,off} = 4.1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		6.95		mJ
Thermal resistance, junction to case	Per diode	$R_{th,Jc}$			0.675	K/W

Module

Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage	RMS, f=50HZ, 1min	V_{ISOL}			2500	V
Stray inductance module		L_{sCE}		30		nH
Operation Junction Temperature		T_{jop}	-40		150	$^\circ C$
Storage Temperature Range		T_{stg}	-40		125	$^\circ C$
Mounting Torque	Screw M6	M	3.0		5.0	N.m
Terminal Connection Torque	Screw M5	M	2.5		5.0	N.m
Weight of Module		G		160		g

Characteristics Diagrams

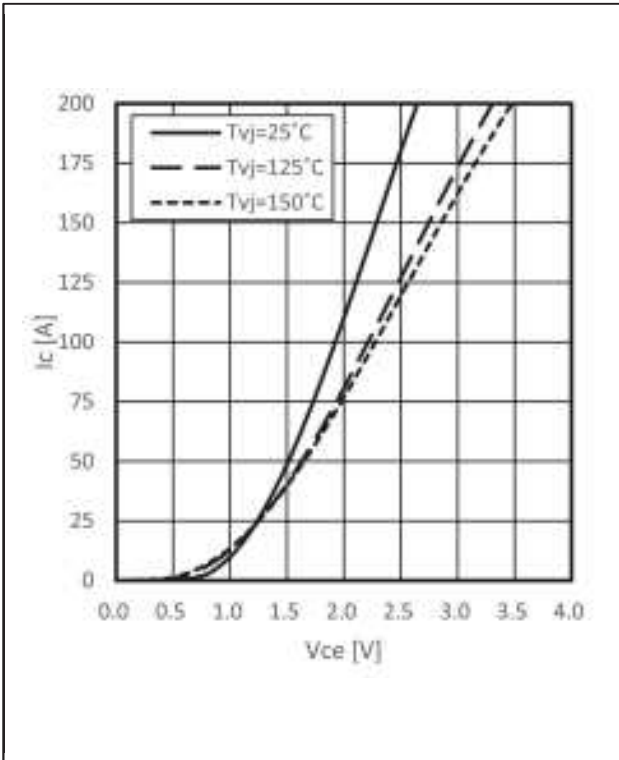


Figure 3 Output characteristic IGBT, Inverter (typical)
 $I_C = f(V_{CE})$
 $V_{GE} = 15V$

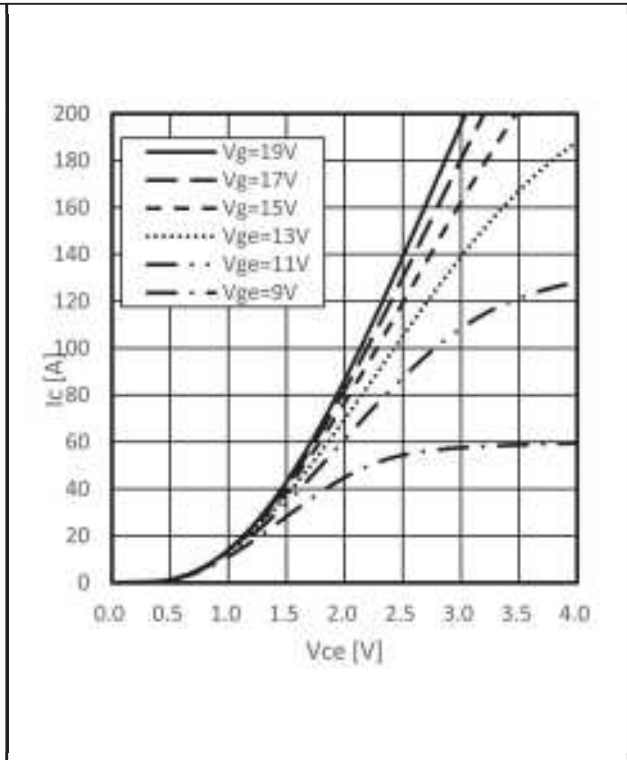


Figure 4 Output characteristic IGBT, Inverter (typical)
 $I_C = f(V_{CE})$
 $T_{vj} = 150^\circ C$

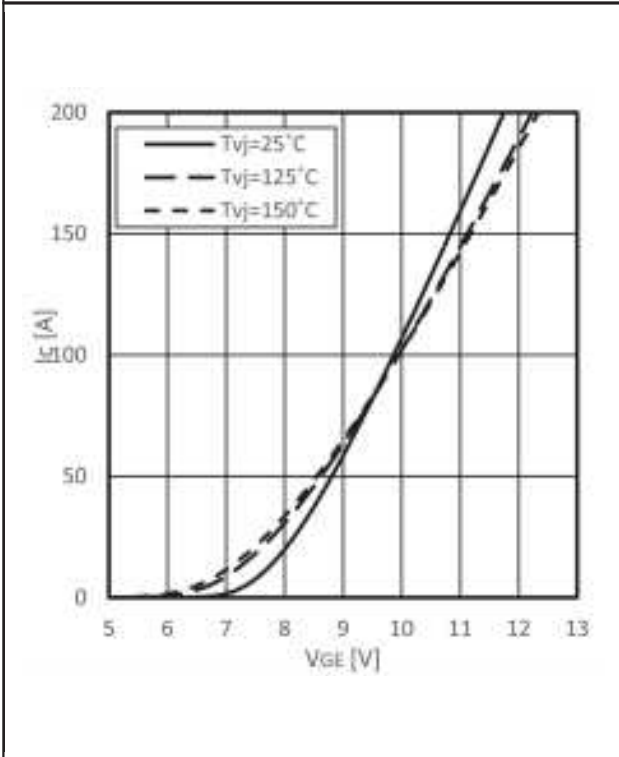


Figure 5 Transfer characteristic IGBT, Inverter (typical)
 $I_C = f(V_{GE})$
 $V_{CE} = 20V$

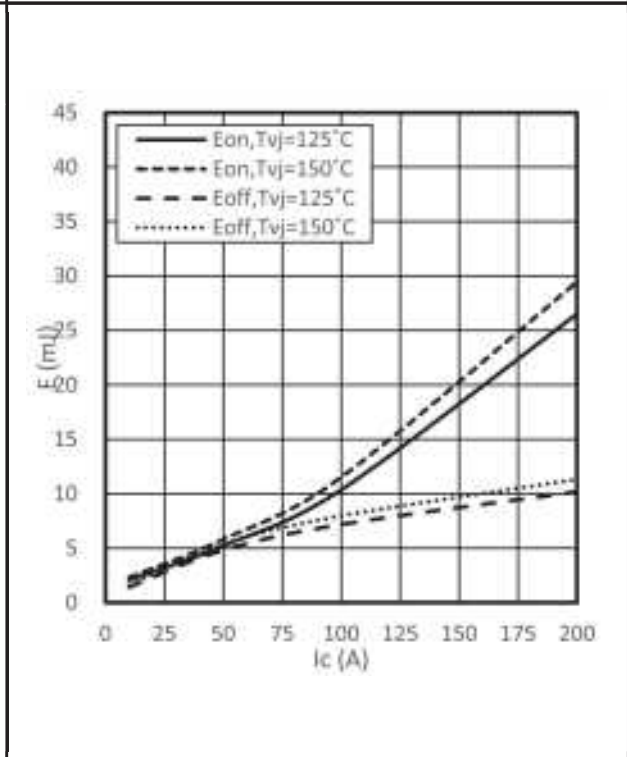


Figure 6 Switching losses IGBT, Inverter (typical)
 $E_{on} = f(I_C), E_{off} = f(I_C)$
 $R_G = 4.1 \Omega, V_{CE} = 600 V, V_{GE} = \pm 15 V$

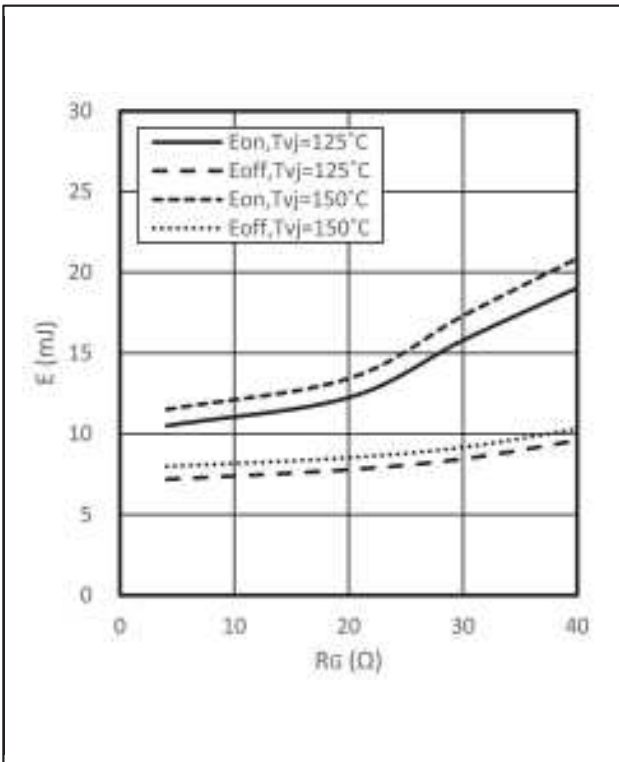


Figure 7 Switching losses IGBT, Inverter (typical)

$E_{on} = f(R_g)$
 $I_c = 100 \text{ A}$, $V_{CE} = 600 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$

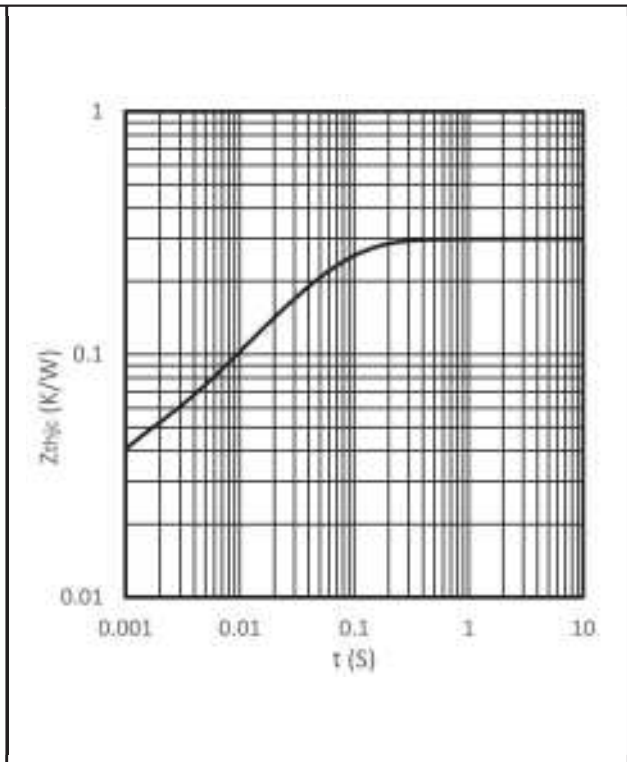
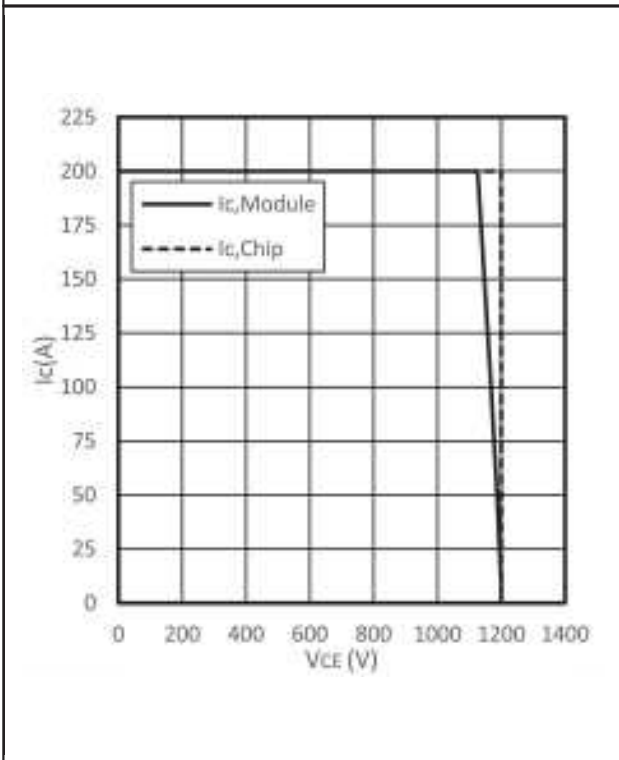


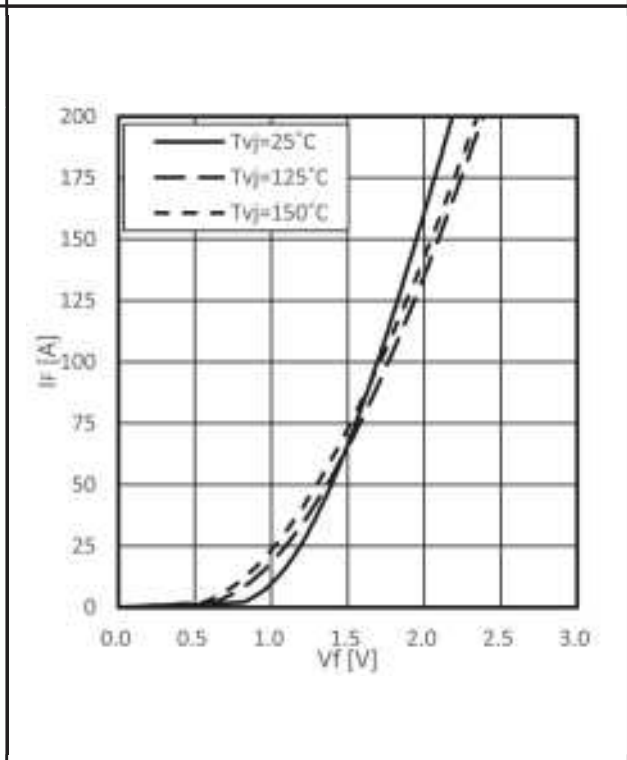
Figure 8 Transient thermal impedance IGBT, Inverter

$Z_{thJC} = f(t)$



F9 Reverse bias safe operating area IGBT, Inverter (RBSOA)

$I_c = f(V_{CE})$
 $V_{GE} = 15 \text{ V}$, $R_{Goff} = 4.1 \Omega$, $T_{vj} = 150^\circ\text{C}$



F10 Forward characteristic of Diode, Inverter (typical)

$I_F = f(V_F)$

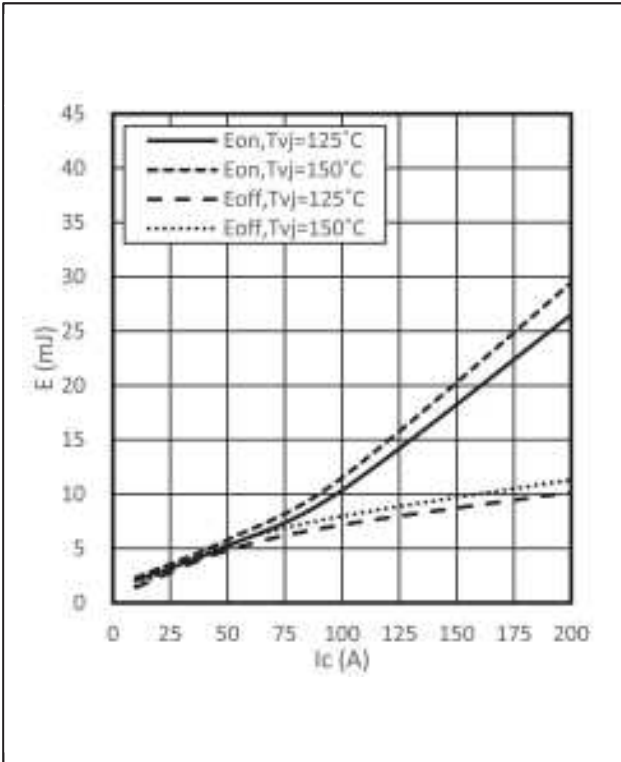


Figure 11 Switching losses Diode, Inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 4.1 \Omega, V_{CE} = 600 V$

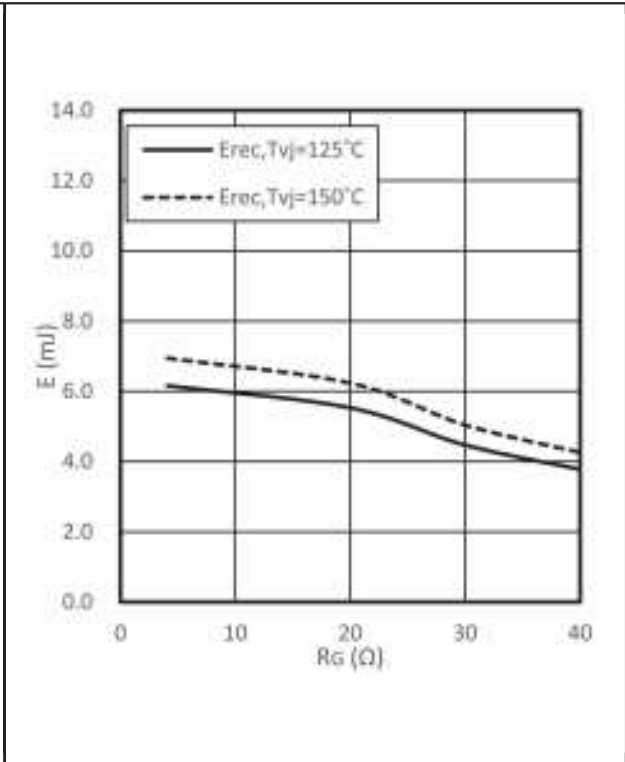


Figure 12 Switching losses Diode, Inverter (typical)
 $E_{rec} = f(R_{Gon})$
 $I_F = 100 A, V_{CE} = 600 V$

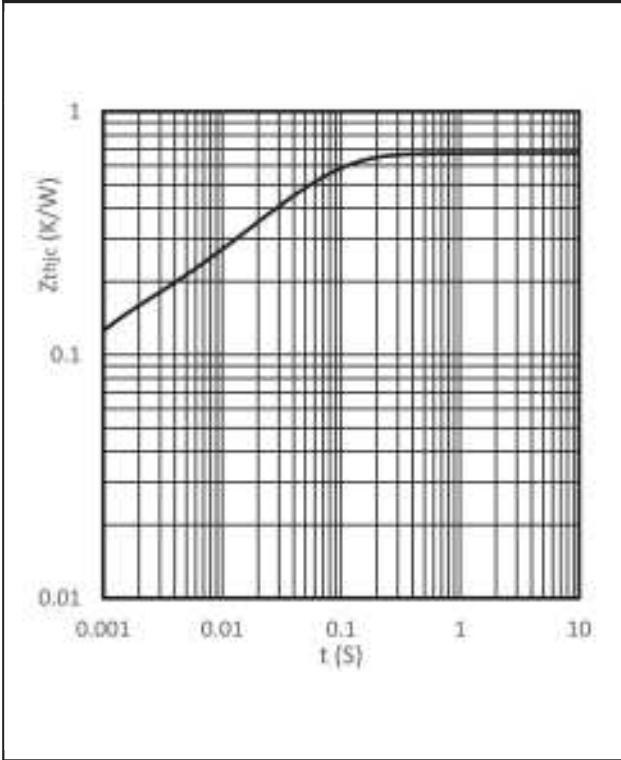
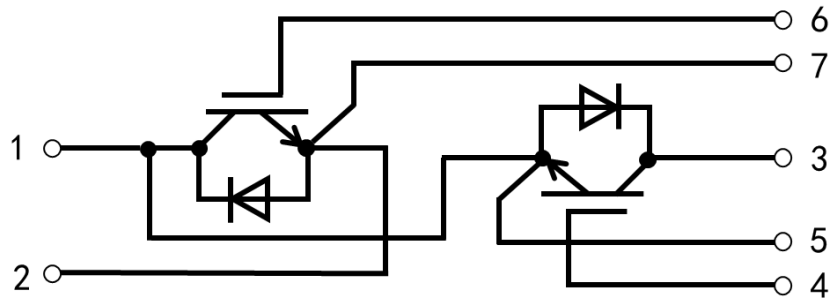


Figure 13 Transient thermal impedance Diode, Inverter
 $Z_{thjc} = f(t)$

Outline:

Circuit Diagram



Package Outlines

